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	UTIL	.ITY	PATENT APP	PLICATI	ON TRA		UPLICATE
Address to: Commissioner for Patents Box PATENT APPLICATION Washington, DC 20231			Attorney Docl	ket No.			
		First Named I					
		Total Pages	4	6	ral.		
	Transmitted herewith is a patent application under 37 CFR 1.53(b).				72 U		
Entitled:	Entitled: Lead-Free Solder				, 8c		
⊠ 1.	1. Submitted herewith are the following:  9 pages of specification, including claims, Abstract. 4 sheets of FORMAL drawings (Fig. 1-5, 6A, 6B, 6C, 6D). 9 claims. 1 Oath/Declaration signed by each inventor. 1 Assignment of the invention to Kwang-Lung LIN, Tainan, Taiwan, Cover Sheet, and payment of the \$40.00 recordal fee. 1 Information Disclosure Statement. 1 pages of Form PTO-1449, and one copy of each document listed thereon. 1 check in the amount of \$410.00 (\$370 - Filing Fee; - \$40 Assignment Recordation Fee).						
⊠ 2.	SMALL ENTITY STATUS IS ASSERTED pursuant to 37 CFR 1.27 for this application.						
□ 3.	The Commissioner is authorized to credit any overpayment and charge any deficiency in any fees required under 37 CFR 1.16 and/or 1.17, to Deposit Account No. 02-0200.						
□ 4.	Insert before the first sentence of the specification: This application claims the benefit of provisional application number filed						
□ 5.	Insert before the first sentence of the specification: This application is a Continuation-in-part of nonprovisional application number filed						
□ 6.	Other:					<u> </u>	
Reg. No. 25	5,893; Richa	rd E. F		882; Thoma	s J. Moore, F	, Reg. No. 19,179; Eug Reg. No. 28,974; Josep	
	THE F	ILING FE	E IS CALCULATED AS FO	LLOWS:		Basic Fee:	\$740.00
	Total Claims:	9	- 20 =		0	X \$18 =	0.00
Indeper	ndent Claims:	1	- 3 =		0	X \$84 =	0.00
Correspondence		ПС			Multiple Dep	Multiple Dependent Claim (add \$280.00):	
		2226	23364		Subtotal:		
		PATENT TRADEMAR		50% Red	uction if Small Entity Status:	370.00	
Phone: 703	-683-0500		Fax: 70	03-683-108	0	Total:	370.00
Da	te:		Name:			Signature:	Reg. No.
January	January 15, 2002 Eugene Mar				2	25,893	





# Application Data Sheet Under 37 § C.F.R. 1.76

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## 3. Application-Information-

Filing status: Small entity

Title of the Invention: Lead-free solder

Class: (when available)
Subclass: (when available)

Technology Center: (when available)
Total number of Drawing Sheets: 4

Docket Number:

Type of Application: Utility